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APPLICATION NO.	FIL	LING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/814,528	10/814,528 03/31/2004		Tom E. Pearson	ITL.1105US (P18745)	6903	
21906	7590	01/24/2006		EXAMINER		
TROP PRU 8554 KATY		•	GIRARDI, VANESSA MARY			
SUITE 100	11022 1111	•		ART UNIT	PAPER NUMBER	
HOUSTON,	TX 7702	24	2833			

DATE MAILED: 01/24/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application No.	Applicant(s)	Applicant(s)			
	Office Antique Comments	10/814,528	PEARSON ET AL.	(Au)			
	Office Action Summary	Examiner	Art Unit				
		Vanessa Girardi	2833				
Period for	- The MAILING DATE of this communication a r Reply	ppears on the cover si	neet with the correspondence addres	\$S			
WHIC - Extensions after \$ - If NO - Failure Any re	PRTENED STATUTORY PERIOD FOR REPHEVER IS LONGER, FROM THE MAILING sions of time may be available under the provisions of 37 CFR (SIX (6) MONTHS from the mailing date of this communication period for reply is specified above, the maximum statutory period to reply within the set or extended period for reply will, by statically received by the Office later than three months after the maid patent term adjustment. See 37 CFR 1.704(b).	DATE OF THIS COM 1.136(a). In no event, however od will apply and will expire SIX ute, cause the application to be	MUNICATION.  , may a reply be timely filed  (6) MONTHS from the mailing date of this commucome ABANDONED (35 U.S.C. § 133).				
Status							
1) 又	Responsive to communication(s) filed on <u>19</u>	December 2005.					
· · · · · · · · · · · · · · · · · · ·		nis action is non-final.					
3)□	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is						
	closed in accordance with the practice under	r <i>Ex parte Quayle</i> , 193	85 C.D. 11, 453 O.G. 213.				
Disposition	on of Claims						
4) 又	Claim(s) <u>1-25</u> is/are pending in the application	on.					
-	la) Of the above claim(s) is/are withd		on.				
5)	Claim(s) is/are allowed.						
6)⊠	Claim(s) <u>1-25</u> is/are rejected.						
7)	Claim(s) is/are objected to.						
8)□	Claim(s) are subject to restriction and	l/or election requireme	ent.				
Application	on Papers						
9) 🗀 🗆	Fhe specification is objected to by the Exami	ner.					
, —	The drawing(s) filed on <u>31 March 2004</u> is/are		objected to by the Examiner.				
	Applicant may not request that any objection to the	ne drawing(s) be held in	abeyance. See 37 CFR 1.85(a).				
	Replacement drawing sheet(s) including the corre	ection is required if the d	rawing(s) is objected to. See 37 CFR 1	.121(d).			
11)[7	The oath or declaration is objected to by the	Examiner. Note the at	tached Office Action or form PTO-	152.			
Priority u	nder 35 U.S.C. § 119						
12) 🗌 A	Acknowledgment is made of a claim for foreign	gn priority under 35 U	S.C. § 119(a)-(d) or (f).				
a)[	☐ All b)☐ Some * c)☐ None of:						
	<ol> <li>Certified copies of the priority docume</li> </ol>	ents have been receive	ed.				
	<ol><li>Certified copies of the priority docume</li></ol>						
	3. Copies of the certified copies of the pr	*		ge			
	application from the International Bure						
* S	ee the attached detailed Office action for a li	st of the certified copi	es not received.				
Attachment	(s)						
1) Notice	e of References Cited (PTO-892)		erview Summary (PTO-413)				
· ==	e of Draftsperson's Patent Drawing Review (PTO-948) nation Disclosure Statement(s) (PTO-1449 or PTO/SB/0		per No(s)/Mail Date tice of Informal Patent Application (PTO-15:	2)			
. —	No(s)/Mail Date	·•,	ner:	•			

## **DETAILED ACTION**

1. The previously held objections within pages 6 and 8 of the Specification have been overcome.

The previously held objections to claims 2, 13 and 14 have been overcome.

The Examiner agrees the amendments made to the Specification overcome the previously held objection of the Drawings whereby those originally submitted are acceptable.

## Claim Rejections

2. Amendment of claims 2 and 13 does not place any of the claims in a condition for allowance therefore, claims 1-25 remain rejected on the grounds outlined in the previous office action of October 3, 2005.

## Response to Applicant's Remarks

3. Applicant contends that Ciambrone's infrared soldering tool holds no value in teachings pertaining to the instant invention of a socket. The Examiner wishes to respectfully return to the Ciambrone reference (Col. 2, lines 10-13), quoted here for your convenience; "The present invention may be of benefit to <u>any manufacturing process using infrared reflow soldering</u> or leaded and combination chip and leaded components."

The instant invention is attempting to improve the process of surface mount techniques that rely on a surface mount oven which generates both convective heat and infrared radiation, which is well-known in the art as infrared reflow soldering.

4. To further substantiate the statement of this process being *well-known* in the art, the Examiner respectfully turns to Edwin et al. (US 5,262,594), cited and relied upon in the previous office action to reject claim 22 of the instant invention. The Edwin et al. reference was filed over 15 years ago. At that point in time, understanding of surface mount techniques employing

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infrared reflow ovens was still being established, as evidenced by the detailed teachings throughout the Edwin et al. reference of the process, its pitfalls and desired outcomes. Turning specifically to (Col. 6, lines 8-17) particularly the statement that IR ovens produce 60% of the heat by natural convection energy and the remaining 40% is generated by infrared energy.

- 5. Further stated is the desire to minimize the amount of time required for passing the PCB through the oven in an attempt to offset potential damage to portions of the PCB not able to withstand such temperatures. This statement makes obvious the need for materials that are virtually invisible to infrared energy thereby facilitating the desired outcome of quickly and accurately applying 40% more of the heat generated by an IR oven as well as allowing for the quick dissipation of this heat once soldering of desired components is complete, thereby minimizing the potential of damage to heat-sensitive components.
- 6. In response to Applicant's remark that there is no suggestion to combine the references, the Examiner recognizes that references cannot be arbitrarily combined and that there must be some reason why one skilled in the art would be motivated to make the proposed combination of primary and secondary references. *In re.Nomiya, 184 USPQ 607 (CCPA 1975)*. However, there is no requirement that a motivation to make the modification be expressly articulated. The test for combining references is what the combination of disclosures taken as a whole would suggest to one of ordinary skill in the art. *In re McLaughlin, 170 USPQ 209 (CCPA 1971)*. References are evaluated by what they suggest to one versed in the art, rather than by their specific disclosures. *In re Bozek, 163 USPQ 545 (CCPA) 1969*. As discussed above, these two references would suggest, to one versed in the art, an integrated socket component that would produce a more reliably soldered product overcoming some of the known pitfalls associated with reflow soldering techniques using an infrared oven.

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Conclusion

Any inquiry concerning this communication or earlier communications from the examiner

should be directed to Vanessa Girardi: Telephone number (571) 272-5924.

Monday – Thursday 7 a.m. - 5:30 p.m. (EST)

If attempts to reach the examiner by telephone are unsuccessful, the examiner's

supervisor, Paula Bradley can be reached on (571) 272-2800 ext 33.

The fax phone number for the organization where this application or proceeding is

assigned is (571) 273-8300.

Information regarding the status of an application may be obtained from the Patent

Application Information Retrieval (PAIR) system. Status information for published applications

may be obtained from either Private PAIR or Public PAIR. Status information for unpublished

applications is available through Private PAIR only. For more information about the PAIR

system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private

PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

VG Art Unit 2833

January 18, 2006

THO D. TA
PRIMARY EXAMINER